onter per RCE 09-19-07

d. 8. q-24-07

# AMENDMENT UNDER 37 C.F.R. § 1.116 EXPEDITED PROCEDURE GROUP 2841 PATENT APPLICATION

#### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q92997

Yasukazu NAKATA, et al.

Appln. No.: 10/567,358

Group Art Unit: 2841

Confirmation No.: 9855

Examiner: Dameon E. LEVI

Filed: February 6, 2006

For:

FLIP CHIP MOUNTING SUBSTRATE

### **AMENDMENT UNDER 37 C.F.R. § 1.116**

### **MAIL STOP AF**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated May 23, 2007, please amend the above-identified application as follows on the accompanying pages.

# TABLE OF CONTENTS

AMENDMENTS TO THE CLAIMS	· · · · · · · · · · · · · · · · · · ·
REMARKS	